

SKM400GAL12V



SEMITRANS® 3

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Features

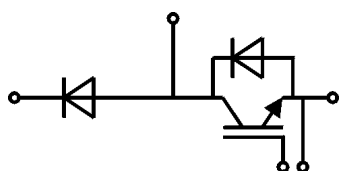
- V-IGBT = 6. Generation Trench V-IGBT (Fuji)
- CAL4 = Soft switching 4. Generation CAL-diode
- Isolated copper baseplate using DBC technology (Direct Copper Bonding)
- UL recognized, file no. E63532
- Increased power cycling capability
- With integrated gate resistor
- Low switching losses at high di/dt

Typical Applications*

- Electronic welders
- DC/DC – converter
- Brake chopper
- Switched reluctance motor

Remarks

- Case temperature limited to $T_c = 125^\circ\text{C}$ max, recomm. $T_{op} = -40 \dots +150^\circ\text{C}$, product rel. results valid for $T_j = 150^\circ$



GAL

Absolute Maximum Ratings

Symbol	Conditions	Values	Unit
IGBT			
V_{CES}	$T_j = 25^\circ\text{C}$	1200	V
I_C	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	612
		$T_c = 80^\circ\text{C}$	467
I_{Cnom}		400	A
I_{CRM}	$I_{CRM} = 3 \times I_{Cnom}$	1200	A
V_{GES}		-20 ... 20	V
t_{psc}	$V_{CC} = 720\text{ V}$ $V_{GE} \leq 20\text{ V}$ $V_{CES} \leq 1200\text{ V}$	$T_j = 125^\circ\text{C}$	10
T_j		-40 ... 175	$^\circ\text{C}$

Inverse diode

I_F	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	440	A
		$T_c = 80^\circ\text{C}$	329	A
I_{Fnom}			400	A
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$		1200	A
I_{FSM}	$t_p = 10\text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$		1980	A
T_j			-40 ... 175	$^\circ\text{C}$

Freewheeling diode

I_F	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	440	A
		$T_c = 80^\circ\text{C}$	329	A
I_{Fnom}			400	A
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$		1200	A
I_{FSM}	$t_p = 10\text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$		1980	A
T_j			-40 ... 175	$^\circ\text{C}$

Module

$I_{t(RMS)}$	$T_{terminal} = 80^\circ\text{C}$	500	A
T_{stg}		-40 ... 125	$^\circ\text{C}$
V_{isol}	AC sinus 50Hz, $t = 1\text{ min}$	4000	V

Characteristics

Symbol	Conditions	min.	typ.	max.	Unit
IGBT					
$V_{CE(sat)}$	$I_C = 400\text{ A}$ $V_{GE} = 15\text{ V}$ chipllevel	$T_j = 25^\circ\text{C}$	1.75	2.20	V
		$T_j = 150^\circ\text{C}$	2.20	2.50	V
V_{CE0}		$T_j = 25^\circ\text{C}$	0.94	1.04	V
		$T_j = 150^\circ\text{C}$	0.88	0.98	V
r_{CE}	$V_{GE} = 15\text{ V}$	$T_j = 25^\circ\text{C}$	2.02	2.9	m Ω
		$T_j = 150^\circ\text{C}$	3.30	3.80	m Ω
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 16\text{ mA}$	5.5	6	6.5	V
I_{CES}	$V_{GE} = 0\text{ V}$ $V_{CE} = 1200\text{ V}$	$T_j = 25^\circ\text{C}$	0.1	0.3	mA
		$T_j = 150^\circ\text{C}$			mA
C_{ies}	$V_{CE} = 25\text{ V}$	$f = 1\text{ MHz}$	24.04		nF
C_{oes}	$V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	2.36		nF
C_{res}		$f = 1\text{ MHz}$	2.356		nF
Q_G	$V_{GE} = -8\text{ V} \dots +15\text{ V}$		4420		nC
R_{Gint}			1.9		Ω



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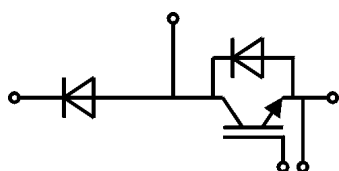
Typical Applications*

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- Switched reluctance motor

Remarks

- Case temperature limited to $T_c = 125^\circ\text{C}$ max, recomm.
 $T_{op} = -40 \dots +150^\circ\text{C}$, product rel. results valid for $T_j = 150^\circ$

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
t _{d(on)}	V _{CC} = 600 V	T _j = 150 °C		350		ns
t _r	I _C = 400 A	T _j = 150 °C		60		ns
E _{on}	V _{GE} = ±15 V	T _j = 150 °C		39		mJ
t _{d(off)}	R _{G on} = 3 Ω	T _j = 150 °C		700		ns
t _f	R _{G off} = 3 Ω	T _j = 150 °C		65		ns
E _{off}	di/dt _{on} = 9800 A/μs	T _j = 150 °C				
	di/dt _{off} = 5000 A/μs					
	du/dt _{off} = 7600 V/μs	T _j = 150 °C		42		mJ
R _{th(j-c)}	per IGBT				0.072	K/W
Inverse diode						
V _F = V _{EC}	I _F = 400 A	T _j = 25 °C		2.20	2.52	V
	V _{GE} = 0 V chip	T _j = 150 °C		2.15	2.47	V
V _{F0}		T _j = 25 °C		1.3	1.5	V
		T _j = 150 °C		0.9	1.1	V
r _F		T _j = 25 °C		2.3	2.5	mΩ
		T _j = 150 °C		3.1	3.4	mΩ
I _{RRM}	I _F = 400 A	T _j = 150 °C		450		A
Q _{rr}	di/dt _{off} = 9500 A/μs	T _j = 150 °C		58		μC
E _{rr}	V _{GE} = ±15 V	T _j = 150 °C		26		mJ
	V _{CC} = 600 V					
R _{th(j-c)}	per diode				0.14	K/W
Freewheeling diode						
V _F = V _{EC}	I _F = 400 A	T _j = 25 °C		2.20	2.52	V
	V _{GE} = 0 V chip	T _j = 150 °C		2.15	2.47	V
V _{F0}		T _j = 25 °C		1.3	1.5	V
		T _j = 150 °C		0.9	1.1	V
r _F		T _j = 25 °C		2.3	2.5	mΩ
		T _j = 150 °C		3.1	3.4	mΩ
I _{RRM}	I _F = 400 A	T _j = 150 °C		450		A
Q _{rr}	di/dt _{off} = 8800 A/μs	T _j = 150 °C		68		μC
E _{rr}	V _{GE} = ±15 V	T _j = 150 °C		30.5		mJ
	V _{CC} = 600 V					
R _{th(j-c)}	per Diode				0.14	K/W
Module						
L _{CE}				15	20	nH
R _{CC'+EE'}	terminal-chip	T _C = 25 °C		0.25		mΩ
		T _C = 125 °C		0.5		mΩ
R _{th(c-s)}	per module			0.02	0.038	K/W
M _s	to heat sink M6		3	5		Nm
M _t		to terminals M6	2.5	5		Nm
						Nm
w					325	g



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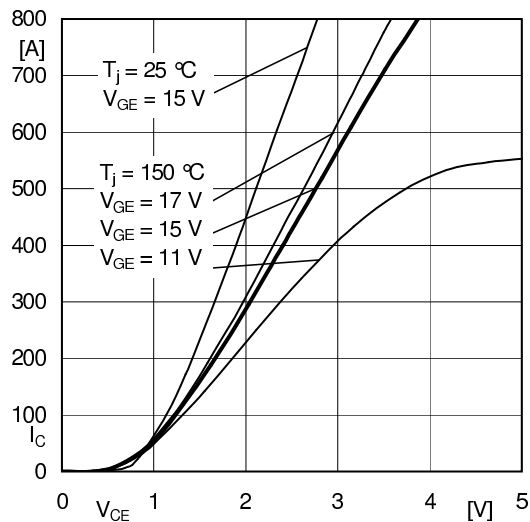


Fig. 1: Typ. output characteristic, inclusive $R_{CC'} + EE'$

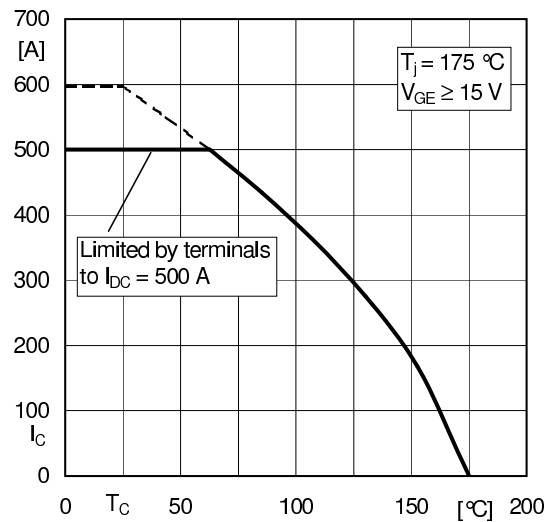


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

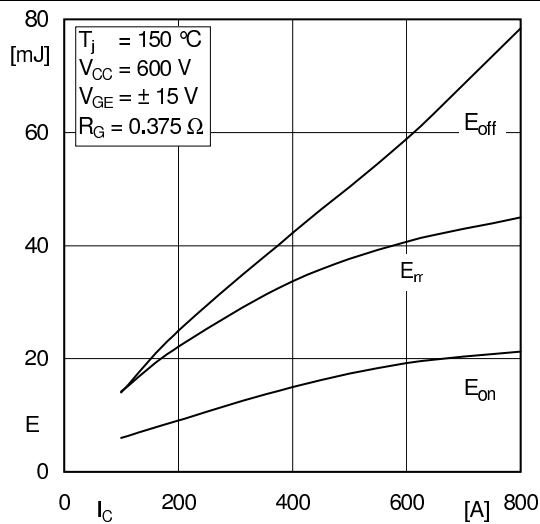


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

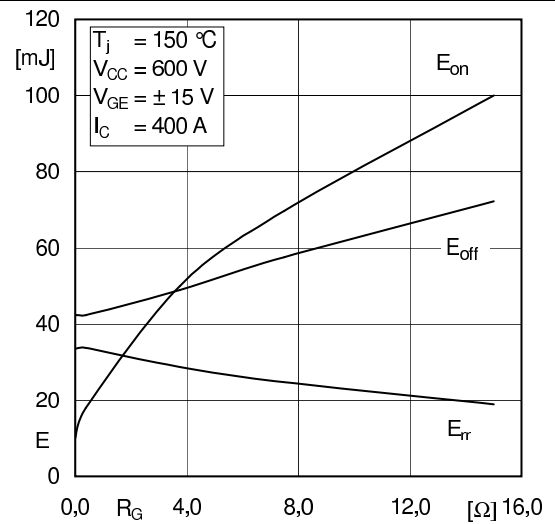


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

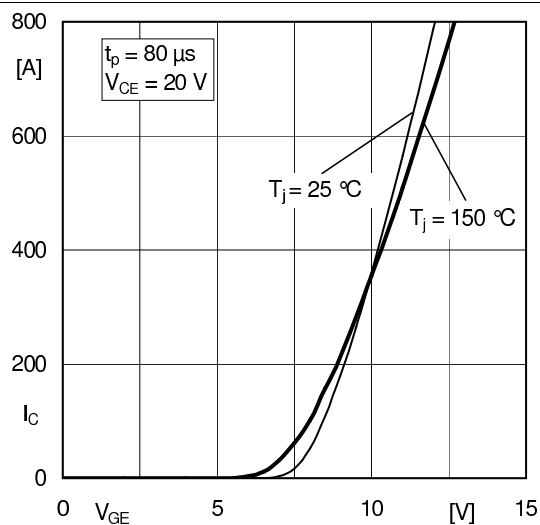


Fig. 5: Typ. transfer characteristic

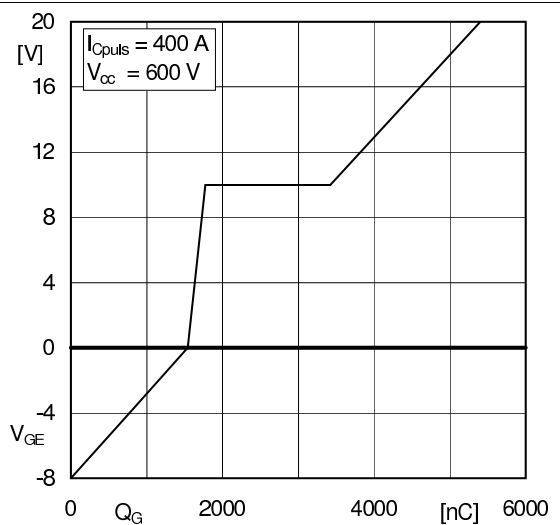


Fig. 6: Typ. gate charge characteristic

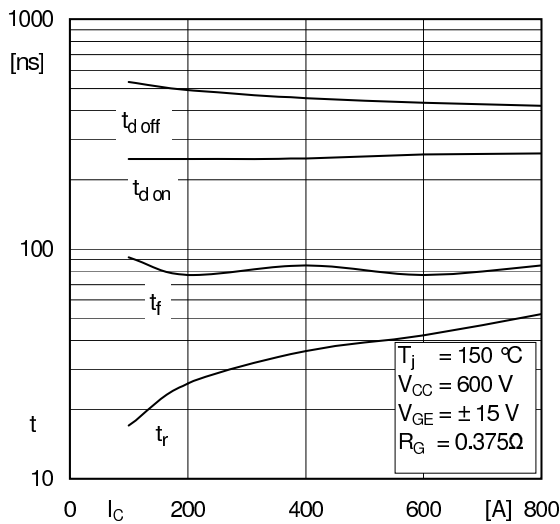


Fig. 7: Typ. switching times vs. I_C

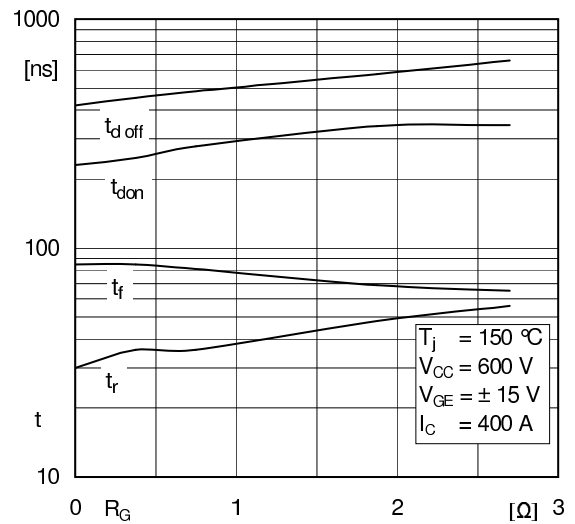


Fig. 8: Typ. switching times vs. gate resistor R_G

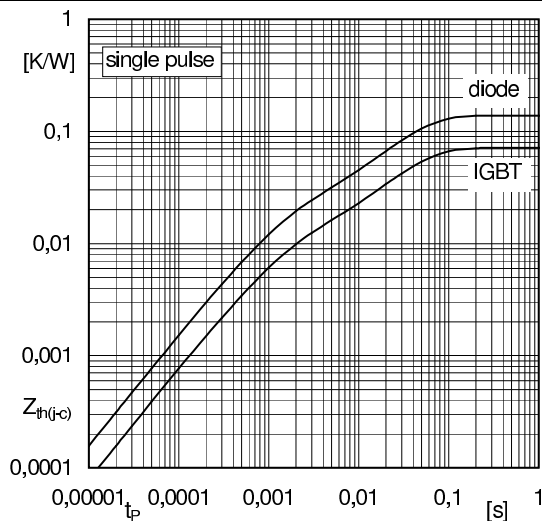


Fig. 9: Transient thermal impedance

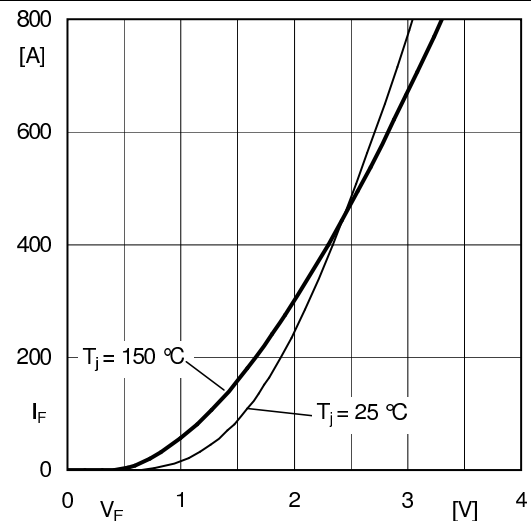


Fig. 10: Typ. CAL diode forward charact., incl. $R_{CC'+EE'}$

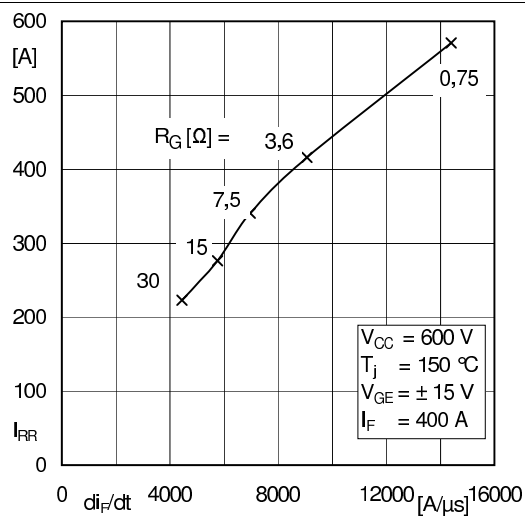


Fig. 11: CAL diode peak reverse recovery current

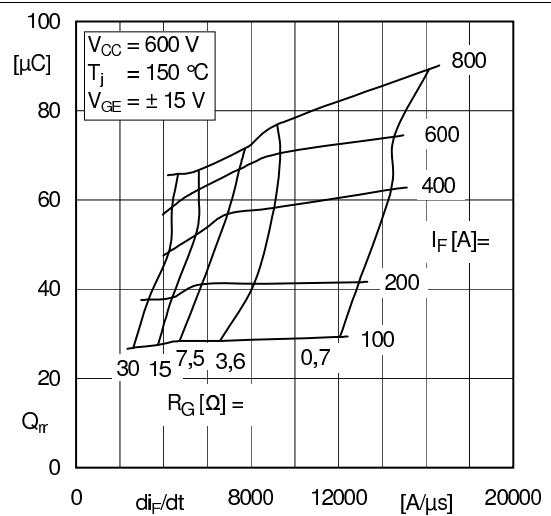
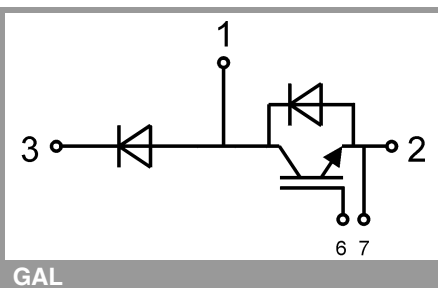


Fig. 12: Typ. CAL diode peak reverse recovery charge



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.